



P2G

N2G

P2D/N2D

40V COMPLEMENTARY ENHANCEMENT MODE MOSFET H-BRIDGE

#### Product Summary

Device	V <sub>(BR)DSS</sub>	R <sub>DS(ON)</sub> max	l <sub>D</sub> max T <sub>A</sub> = +25°C
N Channel	40V	4.5A	
N-Channel	40 V	58mΩ @ V <sub>GS</sub> = 4.5V	4A
P-Channel	401/	65mΩ @ V <sub>GS</sub> = -10V	-3.7A
r-Challinei	-40V	100mΩ @ V <sub>GS</sub> = -4.5V	-2.9A

#### Description

This new generation complementary MOSFET H-Bridge features low on-resistance achievable with low gate drive.

SO-8

Top View

#### Applications

- DC Motor Control
- **DC-AC Inverters**

#### Features

- 2 x N + 2 x P channels in a SOIC package
- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Totally Lead-Free & Fully RoHS compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

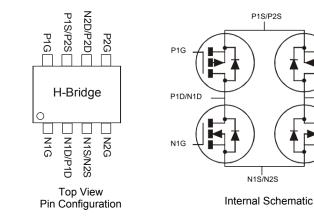
#### **Mechanical Data**

- Case: SO-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See diagram
- Terminals: Finish Matte Tin annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208 @3

P1S/P2S

N15/N25

Weight: 0.074 grams (approximate)





Part Number	Compliance	Case	Packaging
DMHC4035LSD-13	Standard	SO-8	2500/Tape & Reel

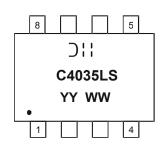
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. Notes:

2. See http://www.diodes.com/quality/lead free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

## Marking Information



O¦ : I = Manufacturer's Marking C4035LS = Product Type Marking Code YYWW = Date Code Marking YY = Year (ex: 13 = 2013) WW = Week (01 - 53)



## Thermal Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Units	
Total Power Dissipation (Note 5)	PD	1.5	W	
Thermal Registeres, Junction to Ambient (Note 5)	Steady State	P	85	
Thermal Resistance, Junction to Ambient (Note 5)	t<10s	$R_{ extsf{ heta}JA}$	53	°C/W
Thermal Resistance, Junction to Case		$R_{ ext{ heta}JC}$	15	
Operating and Storage Temperature Range		$T_{J,} T_{STG}$	-55 to +150	°C

#### **Maximum Ratings N-CHANNEL** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Units		
Drain-Source Voltage	V <sub>DSS</sub>	40	V		
Gate-Source Voltage			V <sub>GSS</sub>	±20	V
	Steady State	T <sub>A</sub> = +25°C T <sub>A</sub> = +70°C	۱ <sub>D</sub>	4.5 3.5	
Continuous Drain Current (Note 5) $V_{GS}$ = 10V	t<10s	T <sub>A</sub> = +25°C T <sub>A</sub> = +70°C	۱ <sub>D</sub>	5.8 4.5	А
	Steady State	T <sub>A</sub> = +25°C T <sub>A</sub> = +70°C	۱ <sub>D</sub>	4 3.1	А
Continuous Drain Current (Note 5) $V_{GS}$ = 4.5V	t<10s	T <sub>A</sub> = +25°C T <sub>A</sub> = +70°C	Ι <sub>D</sub>	5.1 4	А
Maximum Continuous Body Diode Forward Current (Note 5)			I <sub>S</sub>	1.5	А
Pulsed Drain Current (10µs pulse, duty cycle = 1%)			I <sub>DM</sub>	25	А

#### Maximum Ratings P-CHANNEL (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic			Symbol	Value	Units	
Drain-Source Voltage			V <sub>DSS</sub>	-40	V	
Gate-Source Voltage			V <sub>GSS</sub>	±20	V	
		T <sub>A</sub> = +25°C T <sub>A</sub> = +70°C	ID	-3.7 -2.9	А	
Continuous Drain Current (Note 5) V <sub>GS</sub> = -10V	t<10s	T <sub>A</sub> = +25°C T <sub>A</sub> = +70°C	ID	-4.8 -3.8	А	
Continuous Drain Current (Note 5) // 4.5/	Steady State	T <sub>A</sub> = +25°C T <sub>A</sub> = +70°C	ID	-2.9 -2.3	А	
Continuous Drain Current (Note 5) V <sub>GS</sub> = -4.5V	t<10s	T <sub>A</sub> = +25°C T <sub>A</sub> = +70°C	ID	-3.9 -3.0	А	
Maximum Continuous Body Diode Forward Current (Note 5)			I <sub>S</sub>	-1.5	А	
Pulsed Drain Current (10µs pulse, duty cycle = 1%)			I <sub>DM</sub>	-15	А	

Note: 5. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.



## Electrical Characteristics N-CHANNEL (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 6)						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	40	—	_	V	$V_{GS} = 0V, I_D = 250\mu A$
Zero Gate Voltage Drain Current	IDSS	_	—	1	μA	V <sub>DS</sub> = 40V, V <sub>GS</sub> = 0V
Gate-Source Leakage	I <sub>GSS</sub>	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 6)			•	•	•	
Gate Threshold Voltage	V <sub>GS(th)</sub>	1	—	3	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$
Static Drain-Source On-Resistance	Deserver	_	26	45	mΩ	V <sub>GS</sub> = 10V, I <sub>D</sub> = 3.9A
Static Drain-Source On-Resistance	R <sub>DS</sub> (ON)	_	35	58	11122	V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 3.5A
Diode Forward Voltage	V <sub>SD</sub>	_	0.7	1	V	V <sub>GS</sub> = 0V, I <sub>S</sub> = 1.25A
DYNAMIC CHARACTERISTICS (Note 7)			•	•		•
Input Capacitance	Ciss	—	574	_		V <sub>DS</sub> = 20V, V <sub>GS</sub> = 0V, f = 1MHz
Output Capacitance	C <sub>oss</sub>	_	87.8	—	pF	
Reverse Transfer Capacitance	C <sub>rss</sub>	_	38.7	—		
Gate resistance	Rg	_	1.6	_	Ω	$V_{DS}$ = 0V, $V_{GS}$ = 0V, f = 1MHz
Total Gate Charge (V <sub>GS</sub> = 4.5V)	Qg	_	5.9	_		
Total Gate Charge (V <sub>GS</sub> = 10V)	Qg	_	12.5	—	nC	$y_{1} = 20y_{1} + 200$
Gate-Source Charge	Q <sub>gs</sub>	_	1.7	_		V <sub>DS</sub> = 20V, I <sub>D</sub> = 3.9A
Gate-Drain Charge	Q <sub>gd</sub>		2.2	_		
Turn-On Delay Time	t <sub>D(on)</sub>	_	3.1	_		
Turn-On Rise Time	tr	_	2.6	_	1	V <sub>DD</sub> = 20V, V <sub>GS</sub> = 10V,
Turn-Off Delay Time	t <sub>D(off)</sub>	_	15	_	ns	$R_L = 20\Omega, R_G = 6\Omega,$
Turn-Off Fall Time	tf	_	5.5	_	1	
Reverse Recovery Time	t <sub>rr</sub>	_	6.5	_	ns	
Reverse Recovery Charge	Q <sub>rr</sub>	_	1.2	_	nC	- I <sub>F</sub> = 3.9A, di/dt = 500A/μs

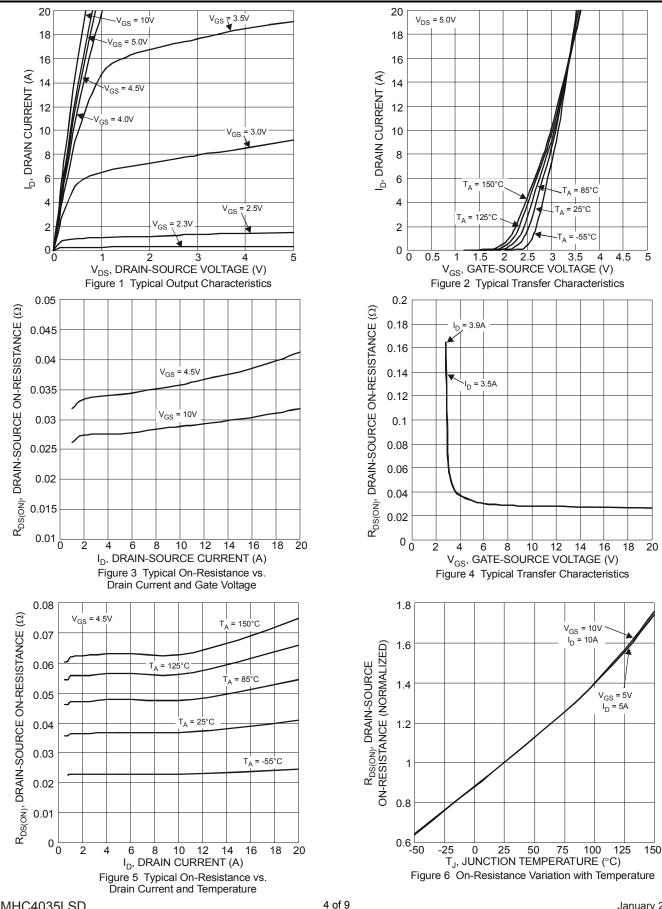
#### Electrical Characteristics P-CHANNEL (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 6)						-
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	-40	—	—	V	$V_{GS} = 0V, I_D = -250\mu A$
Zero Gate Voltage Drain Current	IDSS	_	_	-1	μA	V <sub>DS</sub> = -40V, V <sub>GS</sub> = 0V
Gate-Source Leakage	I <sub>GSS</sub>		_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 6)			•	•	•	·
Gate Threshold Voltage	V <sub>GS(th)</sub>	-1	—	-3	V	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$
Static Drain-Source On-Resistance			49	65		V <sub>GS</sub> = -10V, I <sub>D</sub> = -4.2A
Static Drain-Source On-Resistance	R <sub>DS</sub> (ON)		73	100	mΩ	V <sub>GS</sub> = -4.5V, I <sub>D</sub> = -3.3A
Diode Forward Voltage	V <sub>SD</sub>		-0.7	-1.2	V	V <sub>GS</sub> = 0V, I <sub>S</sub> = -1A
DYNAMIC CHARACTERISTICS (Note 7)			•	•	•	÷
Input Capacitance	Ciss	_	587	—	pF	
Output Capacitance	C <sub>oss</sub>	_	88.1	—	pF	−V <sub>DS</sub> = -20V, V <sub>GS</sub> = 0V, −f = 1MHz
Reverse Transfer Capacitance	C <sub>rss</sub>	_	40.2	—	pF	
Gate resistance	Rg		12.3	_	Ω	$V_{DS}$ = 0V, $V_{GS}$ = 0V, f = 1MHz
Total Gate Charge (V <sub>GS</sub> = -4.5V)	Qg		5.4	_	nC	
Total Gate Charge (V <sub>GS</sub> = -10V)	Qg		11.1	_	nC	
Gate-Source Charge	Q <sub>gs</sub>	_	1.5	_	nC	$-V_{DS} = -20V, I_{D} = -4.2A$
Gate-Drain Charge	Q <sub>gd</sub>	_	2	_	nC	
Turn-On Delay Time	t <sub>D(on)</sub>	_	3.6	_	ns	
Turn-On Rise Time	tr	_	2.9	_	ns	V <sub>DD</sub> = -15V, V <sub>GS</sub> = -10V,
Turn-Off Delay Time	t <sub>D(off)</sub>	_	36.3	_	ns	$R_{G} = 6\Omega, I_{D} = -1A$
Turn-Off Fall Time	tf	_	15.3	_	ns	1
Reverse Recovery Time	trr	_	15.5	—	ns	
Reverse Recovery Charge	Q <sub>rr</sub>		16.9	_	nC	$I_F = -4.2A$ , di/dt = 500A/µs

Notes: 6. Short duration pulse test used to minimize self-heating effect. 7. Guaranteed by design. Not subject to product testing.



#### **Typical Characteristics - N-CHANNEL**

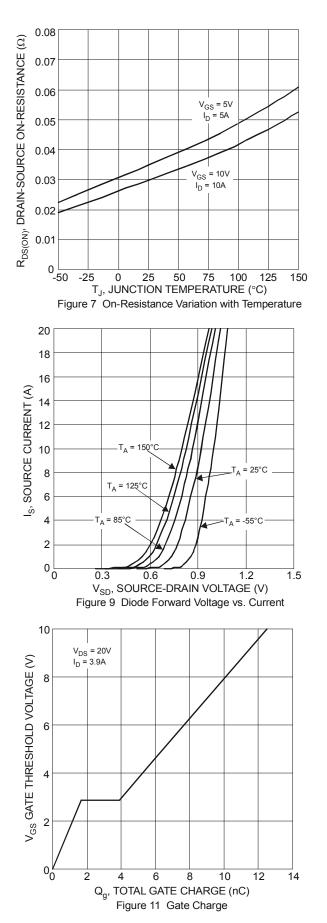


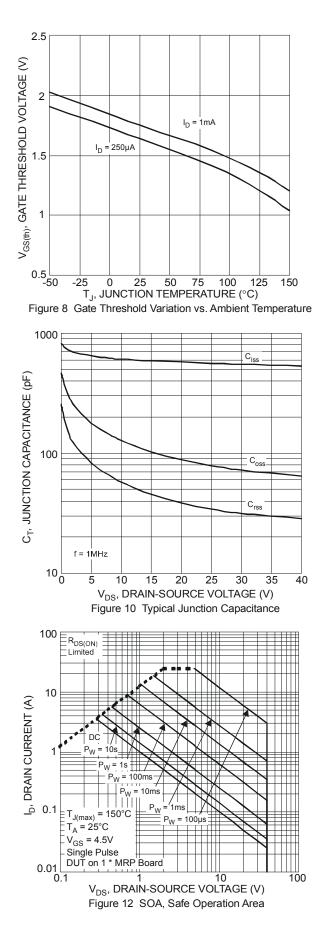
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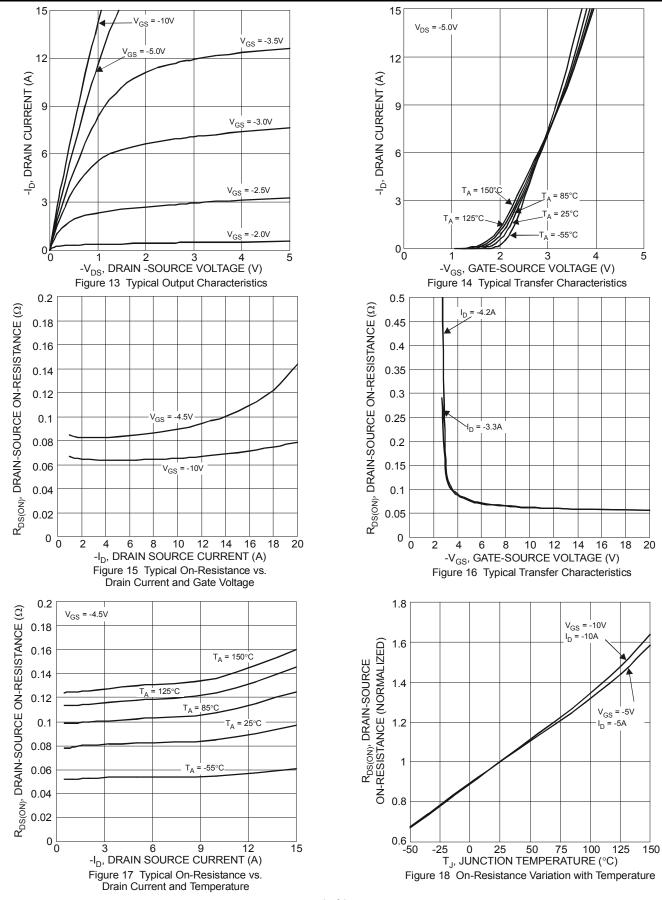


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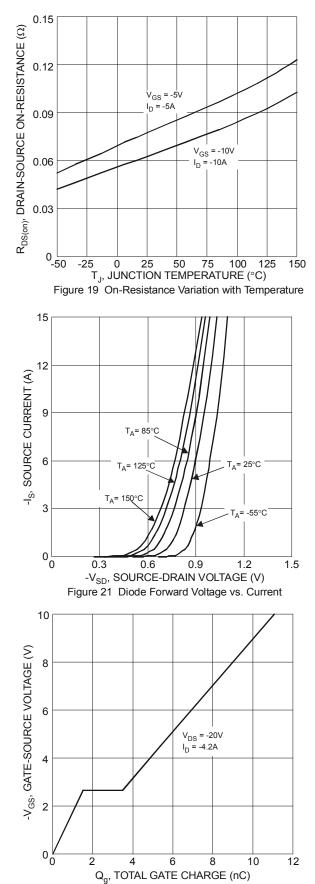
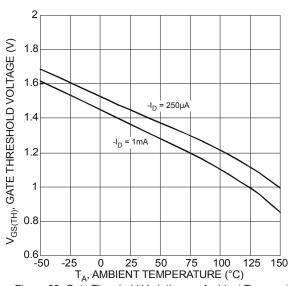
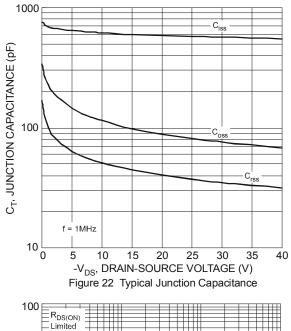
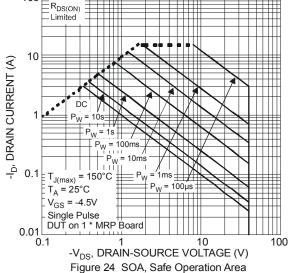


Figure 23 Gate-Charge Characteristics

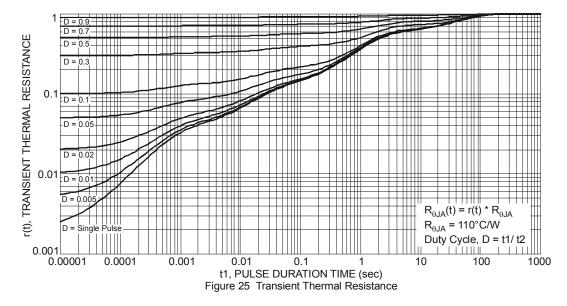






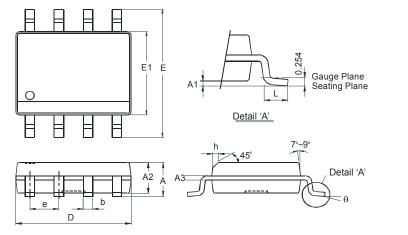






## Package Outline Dimensions

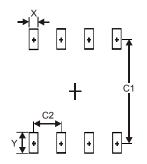
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



	SO-8						
Dim	Min	Max					
Α	-	1.75					
A1	0.10	0.20					
A2	1.30	1.50					
A3	0.15	0.25					
b	0.3	0.5					
D	4.85	4.95					
E	5.90	6.10					
E1	3.85	3.95					
е	1.27	Тур					
h	-	0.35					
L	0.62	0.82					
θ	0°	8°					
All Di	mensions	in mm					

## Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
Х	0.60
Y	1.55
C1	5.4
C2	1.27



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